Preferred Devices

Product Preview

Power MOSFET 5 Amps, 600 Volts

N-Channel TO-220

Designed for high voltage, high speed switching applications in power supplies, converters, power motor controls and bridge circuits.

Features

- Higher Current Rating
- Lower RDS(on)
- Lower Capacitances
- Lower Total Gate Charge
- Tighter V_{SD} Specifications
- Avalanche Energy Specified

Typical Applications

- Switch Mode Power Supplies
- PWM Motor Controls
- Converters
- Bridge Circuits

MAXIMUM RATINGS (T_C = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Drain-Source Voltage	VDSS	600	Vdc
Drain–Gate Voltage ($R_{GS} = 1.0 \text{ M}\Omega$)	V _{DGR}	600	Vdc
Gate–Source Voltage – Continuous – Non–Repetitive (t _p ≤10 ms)	V _{GS} V _{GS}	±20 ±40	Vdc
Drain – Continuous @ T _A 25°C – Continuous @ T _A 100°C – Single Pulse (t _p ≤ 10 μs)	I _D I _{DM}	5 3.8 17.5	Adc Apk
Total Power Dissipation @ T _A 25°C Derate above 25°C Total Power Dissipation @ T _A 25°C (Note 1.)	PD	96 0.77 1.75	Watts W/°C Watts
Operating and Storage Temperature Range	T _J , T _{stg}	–55 to +150	°C
Single Drain–to–Source Avalanche Energy – Starting $T_J = 25^{\circ}C$ ($V_{DD} = 100 \text{ V}, V_{GS} = 10 \text{ Vdc},$ $I_L(pk) = 5 \text{ A}, L = 10 \text{ mH}, V_{DS} = 600$ Vdc, $R_G = 25 \Omega$)	E _{AS}	80	mJ
Thermal Resistance – Junction–to–Case – Junction–to–Ambient	R _θ JC R _θ JA	1.3 62.5	°C/W
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 10 seconds	TL	260	°C

^{1.} Repetitive rating; pulse width limited by maximum junction temperature.

This document contains information on a product under development. ON Semiconductor reserves the right to change or discontinue this product without notice.



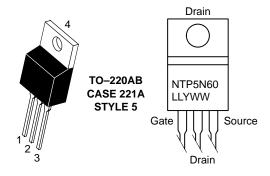
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5 AMPERES 600 VOLTS RDS(on) = 2400 m Ω

N-Channel DO S

MARKING DIAGRAMS AND PIN ASSIGNMENTS



NTP5N60 = Device Code
LL = Location Code
Y = Year
WW = Work Week

ORDERING INFORMATION

Device	Package	Shipping
NTP5N60	TO-220AB	50 Units/Rail

Preferred devices are recommended choices for future use and best overall value.

ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted)

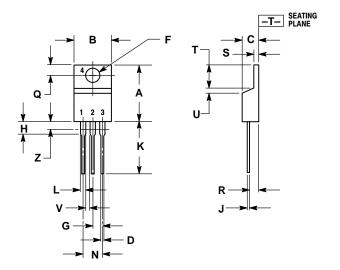
CI	Symbol	Min	Тур	Max	Unit	
OFF CHARACTERISTICS						
Drain-to-Source Breakdown Vo (VGS = 0 Vdc, I _D = 250 μAdd Temperature Coefficient (Pos	V(BR)DSS	600 -	- 700	_ _	Vdc mV/°C	
Zero Gate Voltage Drain Current (VDS = 600 Vdc, VGS = 0 Vdc) (VDS = 600 Vdc, VGS = 0 Vdc, TJ =125°C)		IDSS	_ _	_ _	10 100	μAdc
Gate-Body Leakage Current (V	$V_{GS} = \pm 20 \text{ Vdc}, V_{DS} = 0 \text{ Vdc}$	IGSS	_	-	±100	nAdc
ON CHARACTERISTICS (Note 2	2.)					
Gate Threshold Voltage (V _{DS} = V _{GS} , I _D = 250 μAdc) Temperature Coefficient (Neg	VGS(th)	2.0	2.7 6.0	4.0 -	Vdc mV/°C	
Static Drain-to-Source On-Re	sistance (V _{GS} = 10 Vdc, I _D = 2.5 Adc)	R _{DS(on)}	_	2100	2400	mOhm
Static Drain-to-Source On-Re- (VGS = 10 Vdc, I_D = 5 Adc) (VGS = 10 Vdc, I_D = 2.5 Adc	V _{DS(on)}	_ _	_ _	14.4 13.1	V	
Forward Transconductance (V	os = 15 Vdc, I _D = 2.5 Adc)	9FS	0.7	3.8	_	mhos
DYNAMIC CHARACTERISTICS						
Input Capacitance		C _{iss}	_	540	780	pF
Output Capacitance	$(V_{DS} = 25 \text{ Vdc}, V_{GS} = 0 \text{ Vdc}, $ f = 1.0 MHz)	C _{oss}	-	125	180	-
Transfer Capacitance	,	C _{rss}	-	8.0	20	
SWITCHING CHARACTERISTIC	S (Note 3.)					_
Turn-On Delay Time		^t d(on)	-	12	20	ns
Rise Time	$(V_{DD} = 300 \text{ Vdc}, I_{D} = 5 \text{ Adc},$	t _r	-	7.0	10	
Turn-Off Delay Time	$V_{GS} = 10 \text{ Vdc},$ $R_{G} = 9.1 \Omega)$	t _{d(off)}	-	19	40	
Fall Time		t _f	-	10	20	
Gate Charge	(V _{DS} = 400 Vdc, I _D = 5 Adc, V _{GS} = 10 Vdc)	Q _T	-	5.0	10	nC
		Q ₁	-	2.7	-	1
		Q ₂	-	2.0	-	1
SOURCE-DRAIN DIODE CHAR	ACTERISTICS	•		•		•
Forward On-Voltage (Note 2.)	(I _S = 5 Adc, V _{GS} = 0 Vdc) (I _S = 5 Adc, V _{GS} = 0 Vdc, T _J = 125°C)	V _{SD}	_ _	0.86 0.75	1.0	Vdc
Reverse Recovery Time	(I _S = 5 Adc, V _{GS} = 0 Vdc, dig/dt = 100 A/μs)	t _{rr}	-	655	-	ns
		t _a	_	103	-	
		t _b	_	552	_	1
Reverse Recovery Stored Charge	0	Q _{RR}	_	1.9	_	μС

Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.
 Switching characteristics are independent of operating junction temperature.

PACKAGE DIMENSIONS

TO-220 THREE-LEAD TO-220AB

CASE 221A-09 **ISSUE AA**



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.570	0.620	14.48	15.75
В	0.380	0.405	9.66	10.28
С	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
Н	0.110	0.155	2.80	3.93
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
٧	0.045		1.15	
Z		0.080		2.04

- STYLE 5:
 PIN 1. GATE
 2. DRAIN
 3. SOURCE
 4. DRAIN

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